



DFW

Attorney Docket No. 0553-0394

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In Re Application of:

Shunpei YAMAZAKI et al

Serial No.: 10/757,193

Filed: January 14, 2004

Art Unit: 2826

For: METHOD FOR MANUFACTURING RESIST  
PATTERN AND METHOD FOR MANUFACTURING  
SEMICONDUCTOR DEVICE

) I hereby certify that this correspondence  
) is being deposited with the United States  
) Postal Service as first class mail in an  
) envelope addressed to:  
) Commissioner for Patents, P.O. Box 1450,  
) Alexandria, VA 22313-1450, on July 22,  
) 2005

Cristie M. Neal

Date: July 22, 2005

**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Pursuant to 37 C.F.R. §1.97, as revised on February 4, 1992, 1135 OG 23-24, Applicant hereby calls the Examiner's attention to documents listed on the attached form, which documents may be material to the examination of this application. As this application was filed after June 30, 2003, pursuant to 37 CFR §1.98(a)(2)(i), copies of US patents and US patent application publications are not enclosed herewith.

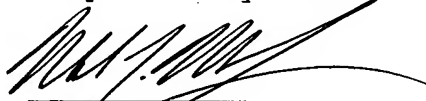
No inference should be drawn that the attached list sets forth a comprehensive investigation of the prior art, that any or all are pertinent to the invention, or that any apparatus disclosed is equivalent to the subject invention.

The citation of the above-discussed documents is not to be construed as an assertion that more pertinent art could not possibly be in existence. Citation of any document herein is not to be construed as an admission that any subject matter disclosed in the document is necessarily within the inventive field of endeavor, that any disclosure is necessarily prior in time to a particular date which may be relevant to the instant patent application, and/or that any disclosure is otherwise necessarily prior art with respect to the instant invention.

Applicant also respectfully reserves the right to later set forth how the instant invention is distinguished over the disclosure of any document or other art, including the disclosure of those documents discussed herein, that may be cited by the Examiner in rejecting a claim in the instant patent application.

A first office action, notice of allowance or issue fee has not been received in this case, so Applicant does not believe that a fee is due. However, if any such fee is required, please charge our Deposit Account No. 50/1039.

Respectfully submitted,



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Mark J. Murphy  
Registration No.: 34,225

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LIST OF PUBLICATIONS  
CITED BY APPLICANT

Atty Docket No.  
0553-0394

Serial No.  
10/757,193

Applicant  
Shunpei YAMAZAKI  
et al

Filing Date  
January 14, 2004

Group  
2826

**U.S. PATENT DOCUMENTS**

*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE
	5,132,248	07/21/92	Drummond et al	437	173	05/31/88
	6,294,401 B1	09/25/01	Jacobson et al	438	99	06/17/99
	6,362,507 B1	03/26/02	Ogawa et al	257	350	04/18/00
	6,514,801 B1	02/04/03	Yudasaka et al	438	151	11/30/00
	US 2003/ 0059987 A1	03/27/03	Sirringhaus et al	438	149	06/21/02
	6,713,389 B2	03/30/04	Speakman	438	674	11/08/02
	US 2004/ 0147113 A1	07/29/04	Yamazaki et al	438	660	01/13/04
	6,794,220 B2	09/21/04	Hirai et al	438	99	08/29/02
	US 2004/ 0253835 A1	12/16/04	Kawase	438	780	08/20/02

**FOREIGN PATENT DOCUMENTS**

	DOCUMENT NUMBER	DATE	APPLICANT	English Abstract	English Trans.	FILING DATE

**OTHER PRIOR ART - NON PATENT LITERATURE DOCUMENTS**

(Include name of author (in CAPITAL LETTERS), title of article or item (book, magazine, journal, serial, symposium, catalog, etc.) date, pages(s), volume-issue number(s), publisher, city and/or country where published).

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EXAMINER:

DATE CONSIDERED:

\*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP form. Draw line through citation if not in conformance and not considered. Include a copy of this form with the next communication to applicant.